TE Internal #: 827137-2

PCB Mount Header, Horizontal, Wire-to-Board, 35 Position, 5 mm [.

197 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder,

Signal, Gray

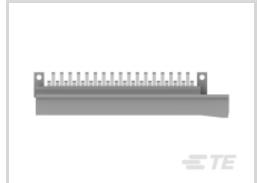
View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > LOW & MEDIUM POWER HEADER











Connector System: Wire-to-Board

Number of Positions: 35

Centerline (Pitch): 5 mm [.197 in]

Sealable: No

PCB Mount Orientation: Horizontal

All LOW & MEDIUM POWER HEADER (153)

Features

Product Type Features

Hybrid Header	No
Connector Shape	Rectangular
PCB Connector Assembly Type	PCB Mount Header
Header Type	Fully Shrouded
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	

Number of Sections	1
Number of Signal Positions	35
Number of Positions	35
PCB Mount Orientation	Horizontal
Number of Rows	2



Body Features

Primary Product Color	Gray
Contact Features	
Contact Size	3mm
Contact Type	Tab
Mating Tab Width	3 mm[.118 in]
Mating Tab Thickness	.8 mm[.031 in]
Contact Mating Area Plating Material	Tin
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mounting Holes	With
Mating Retention	With
Mating Alignment	With
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	Without
Mating Retention Type	Locking Interface
Housing Features	
Centerline (Pitch)	5 mm[.197 in]
Dimensions	
Connector Length	116 mm[4.56 in]
Connector Width	21.2 mm[.834 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Profile Height from PCB	17.7 mm[.696 in]
Operation/Application	
Shielded	No
Circuit Application	Signal
Packaging Features	
Packaging Type	Tray
Packaging Quantity	160
Other	



Interface Number	827667	

Product Compliance

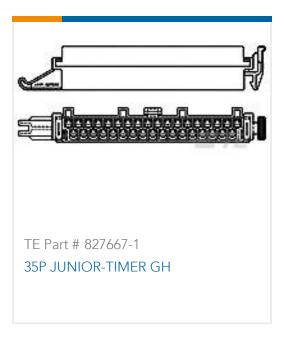
For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2019 (197) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Documents

CAD Files

PCB Mount Header, Horizontal, Wire-to-Board, 35 Position, 5 mm [.197 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Gray



Customer View Model

ENG_CVM_827137-2_M.3d_igs.zip

English

Customer View Model

ENG_CVM_827137-2_M.3d_stp.zip

English

Customer View Model

ENG_CVM_827137-2_M.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

English